Attorney Docket No.:1047 /HIROSE



## **DECLARATION AND POWER OF ATTORNEY**

As a below named inventor, I declare that:

My residence, post office address, and citizenship are as stated next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first, and joint inventor (if plural names are listed below) of the subject matter that is claimed and for which a patent is sought on the invention entitled

## LEAD-FREE SOLDER ALLOY

the specification	of which			
(Check one)	[]	is attached hereto.		
	[X]	was filed on July 8, 2003 as patent application Serial No and was amended on (if any).		
·	[]	was filed on as PCT International Application No and was amended under PCT Article 19 on (if any).		

I have reviewed and understand the contents of the specification identified above, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information that is material to the examination of the patent application identified above in accordance with 37 CFR §1.56(a).

I claim foreign priority benefits pursuant to 35 U.S.C. §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application from which priority is claimed:

Prior Foreign	Application(s)			Priority Claimed
Japan	2002-199666	IT. <b>9</b> 0	LY 2002	Yes <u>X</u> No
(Country)	(Number)		onth/Year Filed)	105 <u>A</u> 110
_ Japan	2002-217925	26 11 1	I V 2002	Voc V No
(Country)	(Number)	26 JULY 2002 (Day/Month/Year Filed)		Yes <u>X</u> No
I claim the ben listed below:	efit pursuant to 35 U.	S.C. §119(e) of any	United States provis	sional application(s)
Application Serial No.		Filing Date	<del></del>	
Application Serial No.		Filing Date	<del></del>	
disclosed in the paragraph of 35 37 CFR §1.56(a	fit pursuant to 35 U.S far as the subject mat prior United States p U.S.C. §112, I acknot effective between the onal filing date of the	ter of each of the cla atent application(s) in whedge the duty to do the filing date of the p	ims of this patent ap n the manner provid lisclose material info prior patent applicati	oplication is not
Application Ser	ial No.	Filing Date	Status (Pat.	/Pend./Aban.)
Application Ser	ial No.	Filing Date	Status (Pat.	/Pend./Aban.)
I appoint:	: <b>м</b>	ichael Tobias, Reg.	32948	
		_		
my attorney with	full power of substit	ution and revocation	to prosecute my ap	plication for Letters

my attorney with full power of substitution and revocation to prosecute my application for Letters Patent identified above and to transact all business in the Patent and Trademark Office connected with that patent application.

I authorize my attorney to accept and follow instructions from S. Hirose and Associates regarding any matter related to the preparation, examination, grant, and maintenance of the application identified above, any continuation, continuation-in-part, or divisional based on the patent application identified above, and any patent issuing from that patent application, until I or my assigns withdraw this authorization in writing.

I direct that correspondence concerning this application be sent to Michael Tobias, #40, 1717 K Street N.W., Suite 613, Washington, D.C. 20036, telephone (301) 587-6541.

I declare that all statements made here based on my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful, false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful, false statements may jeopardize the validity of the patent application identified above or any patent issuing from the patent application identified above.

Full name of sole or first inventor: Masazumi AMAGAI
Inventor's signature Masazum: Amagai
Date 15 Dec 2003  Residence: Tsukuba-shi, Ibaraki Citizenship: Japan  Post Office Address: 2-4-3, Ninomiya, Tsukuba-shi, Ibaraki, Japan
Full name of second joint inventor, if any: Masako WATANABE
Inventor's signature <u>Masako Watanabe</u>
Date 15 Dec 2003 Residence: Oita-shi, Oita Citizenship: Japan Post Office Address: 7-2, Kamishiraki, Oita-shi, Oita, Japan
Full name of third joint inventor, if any: Kensho MURATA
Inventor's signature Kensho Muratio
Date 15 Dec 2003  Residence: Beppu-shi, Oita Citizenship: Japan Post Office Address: 10kumi, Osaka, Beppu-shi, Oita, Japan

[X]

Additional inventors are being named on separately numbered sheets attached hereto.

Osumu Munekata Inventor's signature Date 28 NOV 2003 Residence: Souka-shi, Saitama Citizenship: Japan Post Office Address: 4-20-18, Hanaguri, Souka-shi, Saitama, Japan Full name of fifth joint inventor, if any: Yoshitaka TOYODA Inventor's signature Yoshitaka Toyoda Date 28 Nov. 2003 Residence: Satte-shi, Saitama Citizenship: Japan Post Office Address: 4-16-21, Kahinata, Satte-shi, Saitama, Japan Full name of sixth joint inventor, if any: Minoru UESHIMA Inventor's signature Minoru Veshima Date 28 Nov. 2003 Residence: Misato-shi, Saitama Citizenship: Japan Post Office Address: 2-483-1, Takano, Misato-shi, Saitama, Japan Full name of seventh joint inventor, if any: Tsukasa OHNISHI Inventor's signature Tsuka sa Ohnishi Date 28 Nov. 2003 Residence: Souka-shi, Saitama Citizenship: Japan Post Office Address: 405, Yatsuka-cho, Souka-shi, Saitama, Japan

Full name of fourth joint inventor, if any: Osamu MUNEKATA

Full name of eighth joint inventor, if any: Hiroshi OKADA

Inventor's signature Hiroshi Okada

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